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Applicant: Fernando Gonzalez

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U.S. PATENT DOCUMENTS

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FOREIGN PATENT DOCUMENTS								
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**Examiner Initial	OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)							
	Chang, C., et al., "Enabling Shallow Trench isolation for .01 micrometer Technologies and Beyond", <u>Symposium on VLSI Technology Digest of Technical Papers</u> , pp. 161-162, (1999)							
	Goebel, B., et al., "Vertical N-Channel MOSFETs for Extremely High Density Memories: The Impact of Interface Orientation on Device Performance", <u>IEEE</u> <u>Transactions on Electron Devices. 48(5)</u> , pp. 897-906, (May 2001)							
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